Product Description

3M[™] Thermally Conductive Epoxy Adhesive TC 2810 is a boron nitride filled, two-part, thermally conductive epoxy adhesive.

Key Features

- Improved thermal conductivity.
- Curing performance comparable to 3M[™] Scotch-Weld[™] Epoxy Adhesive DP-460 and DP-460 EG.
- Lower outgassing than Scotch-Weld epoxy adhesive DP-460 or Scotch-Weld epoxy adhesive DP-460 EG.
- Lower chloride ion content than standard epoxies.

Typical Uncured Properties

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Product		3M™ Thermally Conductive Epoxy Adhesive TC-2810
Viscosity	Base Accelerator Mixed	70,000 - 80,000 cps 30,000 - 40,000 cps 50,000 - 70,000 cps
Base Resin	Base Epoxy Accelerator Amine	
Filler	Boron Nitride	24% by weight
Mix Ratio (B:A)	Volume 2:1	
Worklife		60 minutes at 72°F (23°C)
Net Weight (Ib/gal)	Base Accelerator Mixed	10.84 10.28 10.63



Typical Cured Properties

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Product	3M™ Thermally Conductive Epoxy Adhesive TC-2810
Color	Cream
Glass Transition Temperature	See Chart on page 3
Thermal Coefficient of Expansion	62 x 10 ⁻⁶ /°C (below T _g) 205 x 10 ⁻⁶ /°C (above T _g)
Thermal Conductivity*	0.80 - 1.4 W/m-°K
Thermal Impedance**	0.05°C in ² /W (2 mil)
Volume Resistivity	7.58 x 10 ¹² ohm-cm
Dielectric Strength	750 volts/mil
Dielectric Constant	4.6
Dissipation Factor	.09
Total Outgassing	<25 µg/g (GC/MS, 85°C/3 hours)
Hydrocarbon Outgassing	<25 µg/g (GC/MS, 85°C/3 hours)
Siloxane Outgassing	<2 µg/g (GC/MS, 85°C/3 hours)
Extractable Siloxane	<10 µg/g (hexane extraction)
Extractable Chloride	<10 µg/g (hexane extraction)

*Test method dependent.

**Impedance value corrected for interfacial impedance of test method.

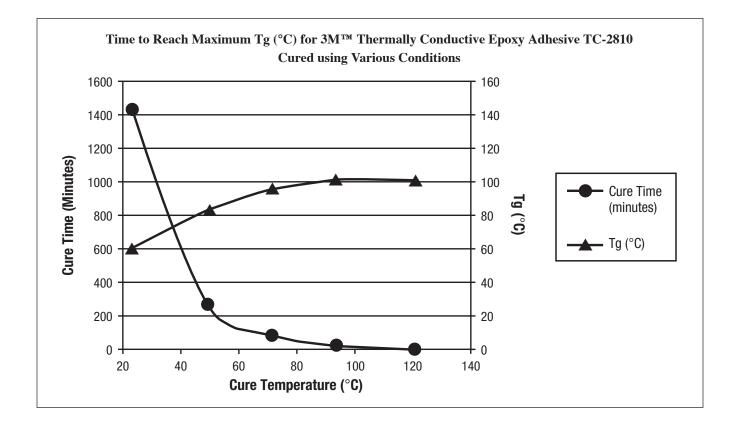
Curing

Cure Schedule: 23°C/24 hours 50°C/270 minutes 70°C/90 minutes 90°C/30 minutes 120°C/10 minutes

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Shear Strength, Peel Strength, Tg vs. Cure Temperature/Time

	72°F (23°C) 24 hours	194°F (90°C) 30 minutes	248°F (120°C) 10 minutes
Overlap Shear (psi) (ASTM D-1002)	3000	3000	3000
T-Peel (piw) (ASTM D-1876)	12	12	12
Shore D Hardness	75	80	80
Tg (°C) Tan Delta	60	100	100



Application and Product Use Notes

For bonding rigid to rigid parts it is suggested that the bond line thickness and edge fillet be designed to optimize:

- i) Bond Strength;
- ii) Thermal Resistance.
- A typical suggested bond line is in the 3-7mil thickness range

For improved thermal performance (lower Thermal Resistance), a thinner bond line is suggested. A thinner bond line can reduce the bond strength so each application needs to be tested to find the correct balance between:

"Bond Line Thickness vs. Thermal Resistance vs. Bond Strength"

A "fillet" at the edges of a bond line is suggested to increase bond strength. The fillets are formed as the epoxy squeezesout past the side edges. Fillets can add strength to the assembly.

3M[™] Thermally Conductive Epoxy TC-2810 is supplied in dual syringe plastic duo-pak cartridges as part of the 3M[™] EPX[™] Applicator System. The duo-pak cartridges are supplied in a 37 ml configuration. To use the 37 ml cartridge simply insert the duo-pak cartridge into the EPX applicator and start the plunger into the cylinders using light pressure on the trigger. Next, remove the duo-pak cartridge cap and expel and discard a small amount of adhesive to be sure both sides of the duo-pak cartridge are flowing evenly and freely (ie: no voids, "plugs of adhesive", dis-continuity in flow, etc.) Once even side to side and uniform flow from both sides of the duo-pak is confirmed, attach the 3M[™] EPX[™] Mixing Nozzle to the duo-pak cartridge to ensure proper and uniform mixing of the Part A and Part B and begin dispensing the adhesive.

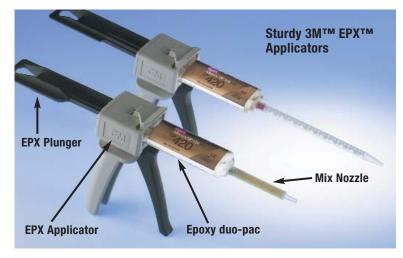
With a 200mil cartridge, the nozzle must be attached before dispensing any material to prevent unmixed adhesive from getting into the applicator cartridge holder. A quantity of material should be dispensed through the mix nozzle and discarded until a uniform color, consistency of product, freely flowing and even side to side flow is evident.

Partially used cartridges must follow the above use instructions to ensure consistent product performance.

Complete and uniform mixing as noted above of the two components is required to obtain consistent product performance.

3M[™] EPX[™] Applicator Mix Nozzles

Use only 3M[™] EPX[™] Applicator and Mix Nozzles to ensure optimum product performance.



Storage and Shelf Life

Storage: Store 3M[™] Thermally Conductive Epoxy Adhesive TC-2810 at 60-80°F (15-27°C) or refrigerate for maximum shelf life and to reduce filler settling.

Shelf Life: Epoxy Adhesive TC-2810 has a shelf life of 12 months after date of shipment in its original container.

General Information

Product selection table for $3M^{\text{TM}}$ Thermally Conductive Materials.

Product	Thickness (mm)	Bulk Thermal Conductivity (W/m-K)	Typical Applications	
3M™ Thermally	Conductive Tapes			
8805	0.127		Applications requiring thin bonding with good thermal transfer; CPU, flex	
8810	0.25	0.6	circuit and power transformer bonding to heat sinks and other cooling devices. Superior tack and wetting properties.	
8815	0.375	0.0		
8820	0.50			
9889FR	1.0	0.5	Applications requiring gap filling and bonding with good thermal transfer; plasma display, IC packages and PCB bonding to heat sinks, metal cases and other cooling devices.	
3M™ Thermally Conductive Pads				
5516/5516S	0.5, 1.0, 1.5, 2.0	2.3	Applications requiring gap filling and superior thermal performance	
5519/5519S	0.5, 1.0, 1.5, 2.0	4.3	without bonding. IC package and PCB thermal interfacing with heat sinks or other cooling devices and metal cases.	
5591S	0.5, 1.0, 1.5, 2.0	1.0		
5592/5592S	0.5, 1.0, 1.5, 2.0	1.1		
5595/5595S	0.5, 1.0, 1.5, 2.0	1.6		
3M™ Thermally Conductive Pads (Acrylic)				
5598H	1.0, 1.5	2.0	These pads use an acrylic elastomer for applications that require a non-	
5590H	0.5, 1.0, 1.5	3.0	silicone thermal pad. Provides IC package and PCB thermal interfacing with heat sinks or other cooling devices, and metal cases.	
3M™ Thermally Conductive Epoxy Adhesives				
TC-2707	_	0.7	Applications requiring high adhesive strength, good surface wet-out, gap	
DP-190 Gray	_	0.4	filling and good thermal transfer. Provides IC package and PCB thermal interfacing with heat sinks or other cooling devices.	

Only the "S" versions are available in 0.5 mm thicknesses.

"S" designation signifies a polyester film on one side to provide a non-tacky surface.

"H" designation signifies a product with one one-tacky surface without the use of PET film.

Precautionary Information

Refer to Product Label and Material Safety Data Sheet for Health and Safety Information before using this product. For additional health and safety information, call 1-800-364-3577 or (651) 737-6501.

For Additional Information

To request additional product information or to arrange for sales assistance, call toll free 1-800-251-8634. Address correspondence to: 3M Electronics Markets Materials Division, Building 21-1W-10, 900 Bush Avenue, St. Paul, MN 55144-1000. Our fax number is 651-778-4244 or 1-877-369-2923. In Canada, phone: 1-800-364-3577. In Puerto Rico, phone: 1-787-750-3000. In Mexico, phone: 52-70-04-00.

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